

NOT RECOMMENDED FOR NEW DESIGN USE SBR8M100P5

SDM8M100P5

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM}	100	V
Average Rectified Output Current	Io	8	А
Non-Repetitive Peak Forward Surge Current 8.3ms	I _{FSM}	160	Α
Non-Repetitive Avalanche Energy at I _{AS} = 3.0A, L = 50mH	E _{AS}	210	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	20	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R ₀ JC	3	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V _F		0.73 0.78 0.58 0.64	0.85 - 0.74	V	I _F = 4A, T _J = +25°C I _F = 8A, T _J = +25°C I _F = 4A, T _J = +125°C I _F = 8A, T _J = +125°C
Leakage Current (Note 6)	IR) = ,	0.1 0.15	1.5 2.0		V _R = 100V, T _J = +25°C V _R = 100V, T _J = +125°C
Junction Capacitance	CJ		168	_	pF	V _R = 4V, T _J = +25°C

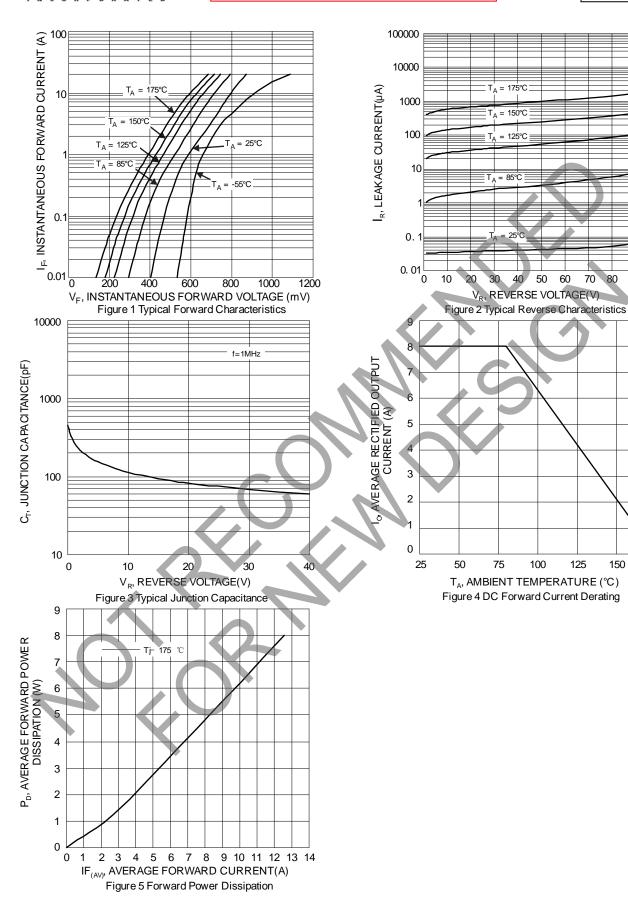
Notes:

5. 2-inch sq. Al board.6. Short duration pulse test used to minimize self-heating effect.

100

175



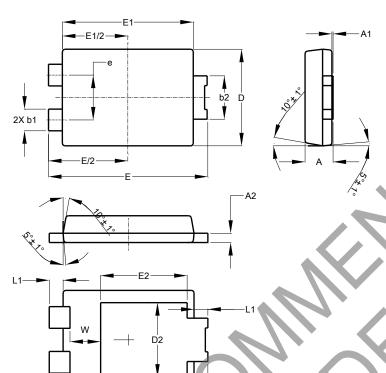




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5

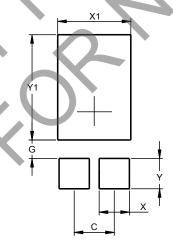


PowerDI5				
Dim	Min	Max	Тур	
Α	1.05	1.15	1.10	
A1	0.00	0.05		
A2	0.33	0.43	0.381	
b1	0.80	0.99	0.89	
b2	1.70	1.88	1.78	
D	3.90	4.05	3.966	
D2			3.054	
E	6.40	6.60	6.504	
е	1	İ	1.84	
E1	5.30	5.45	5.37	
E2	1		3.549	
ď	0.75	0.95	0.85	
L1	0.50	0.65	0.57	
W	1.10	1.41	1.255	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	1.390
X1	3.360
Y	1.400
V1	4.860



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